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NORME INTERNATIONALE

Field device integration (SOI) ANDARD PREVIEW Part 100: Profiles – Generic protocols (standards.iteh.ai)

Intégration des appareils de terrain (FDI) – Partie 100: Profils – Protocoles génériques st/112cfa5d-4b7d-4e85-9892ddbbf8250787/iec-62769-100-2020





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NORME INTERNATIONALE

Field device integration (FDI) ANDARD PREVIEW Part 100: Profiles – Generic protocols ds.iteh.ai)

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FIELD DEVICE INTEGRATION (FDI) -

Part 100: Profiles – Generic protocols

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FCG TS62769-100 Edition 1.1, *Field Device Integration Part 100: Profiles – Generic Protocols*, a specification of the FieldComm Group, PROFIBUS Nutzerorganisation e. V., OPC Foundation and FDT Group, serves as a basis for the elaboration of this standard.

The text of this International Standard is based on the following documents:

FDIS	Report on voting
65E/739/FDIS	65E/743/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be

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FIELD DEVICE INTEGRATION (FDI) -

Part 100: Profiles – Generic protocols

1 Scope

This part of IEC 62769 specifies an FDI profile of IEC 62769 for generic protocols. That means that all interfaces are defined, and a host can add support for more protocols without changing its implementation. Nevertheless, there are some protocol-specific definitions (PSD) that need to be specified per protocol using this profile. Annex C specifies what PSDs need to be defined per protocol so that FDI Device Packages, FDI Communication Packages for Gateways and FDI Communication Servers, FDI Communication Servers, Gateways and Devices supporting such a protocol can work together in a host not aware about this specific protocol.

NOTE A host not using an FDI Communication Server but a proprietary mechanism for communication defines its own means to deal with this profile to support several protocols without changing its implementation. This is specific to the proprietary way how the communication driver is bound to the host.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

<u>IEC 62769-100:2020</u>

IEC 61804 (all parts), Function blocks (FB) for process control and Electronic Device dobbe 25078//cc-62/69-100-2020

IEC 61804-3, Function blocks (FB) for process control and Electronic Device Description Language (EDDL) – Part 3: EDDL syntax and semantics

IEC 62541-100:2015, OPC Unified Architecture – Part 100: OPC UA for Devices

IEC 62769-2, Field Device Integration (FDI) – Part 2: FDI Client

IEC 62769-4, Field Device Integration (FDI) – Part 4: FDI Packages

IEC 62769-5, Field Device Integration (FDI) – Part 5: FDI Information Model

IEC 62769-7, Field Device Integration (FDI) – Part 7: FDI Communication Devices

3 Terms, definitions, abbreviated terms and conventions

For the purposes of this document, the terms and definitions given in IEC 61804 series, IEC 62541-100, IEC 62769-2, IEC 62769-4, IEC 62769-5 and IEC 62769-7 apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at http://www.electropedia.org/
- ISO Online browsing platform: available at http://www.iso.org/obp

3.1 Abbreviated terms

- EDD electronic device description
- EDDL Electronic Device Description Language (see IEC 61804)
- FDI[™] Field Device Integration^{™ 1}
- FCG FieldComm Group
- XML Extensible Markup Language (see FCG TS62769-100, Edition 1.1, Field Device Integration Part 100: Profiles – Generic Protocols, available at https://fieldcommgroup.org)

3.2 Conventions

3.2.1 EDDL syntax

This document specifies content for the EDD component that is part of FDI Communication Packages. The specification content using EDDL syntax uses the font Courier New. The EDDL syntax is used for method signature, variable, data structure and component declarations.

3.2.2 XML syntax

XML syntax examples use the font Courier New. The XML syntax is used to describe XML document schema.

Example: <xs:simpleType name="ExampleType"PREVIEW

3.2.3 Capitalizations (standards.iteh.ai)

The IEC 62769 series uses capitalized (terms) to (emphasize that these terms have an FDI-specific meaning. https://standards.iteh.ai/catalog/standards/sist/112cfa5d-4b7d-4e85-9892-

ddbbf8250787/iec-62769-100-2020

Some of these terms use an initialism as a prefix, for example:

- FDI Client, or
- FDI Server.

Some of these terms are compound terms, such as:

- Communication Servers, or
- Profile Package.

Parameter names or attributes are concatenated into a single term, where the original terms start in this term with a capital letter, such as:

- ProtocolSupportFile or
- ProtocolType.

Parameter names or attributes can also be constructed by using an underscore character to concatenate two or more terms, such as:

- DEVICE_REV or
- DEVICE_MODEL

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4 **Profile for Generic Protocols**

4.1 General

This profile document to the FDI specification in IEC 62769 specifies the protocol specifics needed for FDI Packages describing Communication Servers, Gateways and Devices.

For Communication Servers, this document defines protocol specifics as these need to be considered in the Information Model hosted by the Communication Servers.

4.2 Catalog profile

4.2.1 **Protocol support file**

4.2.1.1 FDI Device Package

Protocol-specific attachments are mentioned in the Package Catalog as defined in IEC 62769-5. As this document defines a profile generically suitable for many protocols, it does not define requirements for any protocol-specific attachments. However, it does also not prevent the usage of protocol-specific attachments. The PSDs (see Annex C) define the requirements on the need of ProtocolSupportFiles for a specific protocol. However, the configuration of a device using an FDI Device Package shall not require the usage of a protocol-specific attachment. Table 1 specifies the parameters of the ProtocolSupportFile in the FDI Device Package in case one or many are provided.

Table 1 – Protocol Support File for FDI Device Packages

(standards itab ai)					
Parameter Description					
Content Type	text/plain IEC 62769-100:2020				
Root Namespace	tpmptyindards.iteh.ai/catalog/standards/sist/112cfa5d-4b7d-4e85-9892-				
Source Relationship http://fdi-cooperation.com/2010/relationship/attachment-protocol					
Filename	Not defined				

4.2.1.2 FDI Communication Packages

The same rules as for FDI Device Packages apply.

4.2.2 CommunicationProfile definition

IEC 62769-4 defines a CommunicationProfileT string for the Catalog XML schema. The string is protocol-specific and defined as ProfileIdentifier in the PSD (see Annex C).

4.2.3 Profile device

A Profile Package shall provide the catalog values for profile devices, enabling the FDI Server to leverage a generic device description, if a specific one is not available. The definitions in Table 2 focus on catalog content that is vendor-independent.

Element	Attribute	Content	
PackageType		Profile	
Manufacturer		Empty	
DeviceModel —		The format of the DeviceModel is protocol specific and details on the format are defined in the PSD (see Annex C).	
		In order to assign a scan result with a profile package the ProfileId of the scan result shall be mapped to the DeviceModel of the profile package.	

Table 2 – Catalog values for profile devices

4.2.4 Protocol version information

IEC 62769-4 defines an element type named InterfaceT for the Catalog XML schema. The element type InterfaceT contains an element named Version, which is supposed to provide version information about the applied communication protocol profile. The value shall follow the IEC 62769-4 defined version information schema defined in the element type VersionT. The PSDs (see Annex C) define the mapping of versions of a specific protocol to this field.

4.3 Associating a Package with a device

4.3.1 Device type identification mapping

The purpose of device-type identification mapping is to enable FDI host systems to compare the scan result against the topology representation in the Information Model. FDI host systems shall also be enabled to determine the FDI Device Package that fits for a device entry contained in the scan result. This will enable the user of an FDI host system to synchronize the Information Model with the actual installation.

IEC 62769-100:2020

The Communication Server implemented scan service 2(defined in 4.69197) provides the scan result through an XML document (the schema is defined) in Olause A.5).

The Gateway implemented scan service (defined in 4.6.2.7) provides the scan result by means of the Information Model that contains data structures created from EDD content as specified in 4.6.2.7.

For both ways of presenting the scan result, it is common that scan results contain device type identification and device instance identification.

FDI host systems comparing the actual network topology configuration against the topology representation in the Information Model shall be enabled to handle the following situations:

- a) The physical Device instance identified at a specific device address is not logically present in the Information Model (as Instance): enable the FDI Host system to find the appropriate FDI Device Package according to the device catalog information.
- b) The physical Device instance identified by the device address is logically present in the Information Model (as Instance): enable the FDI Host system to compare device type information presented in scan result (see the identification in Clause A.5) and the device type specific information of the Instance present in the Information Model.

The FDI Device Package contains device type identification information that can be compared to the scan results based on the Catalog Schema in IEC 62769-4 defining the XML (simple) element types "DeviceModel" and "Manufacturer". Both types are used in the (complex) element types "Protocol" and "RegDeviceType".

As a result of the FDI Package deployment, the FDI Package information is then present in the Information Model as the specified FunctionalGroup Identification containing SerialNumber and Tag (see 4.4.3).

The mapping between different device identification data sources is described in Table 3. Since scan results provided by the Communication Server or Gateway can convey data that is produced by the device (firmware), the device type identification mapping shall be supported by providing corresponding data in the Catalog and Information Model contained in the FDI Device Package.

FDI Device Package	Information Model	Information Model Communication Server provided scan result	
Catalog specified type Manufacturer	FunctionalGroup: Identification Browse Name: Manufacturer	Element (path): ConnectionPoint/Identification Attribute: Manufacturer	COLLECTION ConnectionPoint. Identification: Manufacturer
Catalog specified type DeviceModel	FunctionalGroup: Identification Browse Name: DeviceModel	Element (path): ConnectionPoint/Identification Attribute: DeviceModel	COLLECTION ConnectionPoint. Identification. DeviceModel

 Table 3 – Device identification information mapping

Since not all protocols that are intended to be used with this profile for generic protocols might support a mandatory discovery mechanism allowing to identify the type of device (Manufacturer and DeviceModel), the scan results provide the capability to exclude the identification of the device and only provide the address. In that case, some host-specific mechanisms can be used to assign the desired FDI package to the device, for example by user interaction.

Since some protocols do not even have the mandatory capabilities to identify if there is a device at all for a specific protocol, address hosts should provide the capability for some users to add devices by manually specifying address information.

https://standards.iteh.ai/catalog/standards/sist/112cfa5d-4b7d-4e85-9892-

4.3.2 Device type revision mapping 0787/iec-62769-100-2020

IEC 62769-4 envisions a concept that allows to determine the compatibility between an FDI Device Package and a Device. IEC 62769-4 specifies a lifecycle management process bearing on a single version information provided for the entire device. This is captured in the DeviceRevision (see Table 4). Mapping of version information is protocol-specific and needs to be defined in the PSDs (see Annex C).

FDI Device Package	Information Model	Communication Server provided scan result	Gateway provided scan result	
Catalog specified type ListOfSupportedDeviceRevisions	FunctionalGroup: Identification Browse Name: DeviceRevision	Element (path): ConnectionPoint/Identification Attribute: DeviceRevision	COLLECTION ConnectionPoint. Identification. DeviceRevision	

 Table 4 – Device revision information mapping

4.4 Information Model mapping

4.4.1 **ProtocolType definition**

In Table 5, a subtype of ProtocolType is defined to identify network communication using this profile.

Attribute	Value				
BrowseName	GenericProtocol				
IsAbstract	False				
References	NodeClass	BrowseName	DataType	TypeDefinition	ModellingRule
Subtype of the ProtocolType defined in IEC 62541-100.					
HasProperty	Variable	Protocolldentifier	String	PropertyType	Mandatory

Table 5 – Protocol type GenericProtocol

The mandatory Variable Protocolldentifier defines which concrete protocol is represented using the GenericProtocol type. It shall match the Protocolldentifier defined for the CommunicationProfile in 4.2.2. The string is protocol-specific and defined as ProfileIdentifier in the PSDs (see Annex C).

4.4.2 DeviceType mapping

Each device type inherits the properties of DeviceType. The mapping of the inherited properties from DeviceType is defined in Table 6. Note that only the attributes defined in Annex C, and therefore expected by each generic protocol, are used. Specific protocols can provide, for example, a SoftwareRevsion, but since this is not accessible for the host, this profile does not make use of it.

(stondords itch oi)				
	Property (Stan	Generic Protocol Mapping		
SerialNumber	I	FC 62765 SerialNumber (see Annex C)		
RevisionCounter	https://standards.iteh.ai/cata	log/standard1/1801 defined) 4b7d-4e85-9892-		
Manufacturer	ddbbf82	50787/icc String taken from FDI package catalog (ManufacturerName from PackageT)		
Model		String taken from FDI package catalog (Name of DeviceTypeT, which is a localized name)		
DeviceManual		empty text string (not supported) ^a		
DeviceRevision		DeviceRevision (see Annex C)		
SoftwareRevision		empty string (not defined)		
HardwareRevision		empty string (not defined)		
^a Device manuals	are exposed as attachment	s of the FDI Device Package.		

Table 6 - Inherited DeviceType property mapping

4.4.3 FunctionalGroup identification definition

As defined in IEC 62541-100:2015, 5.3, each device representation in the FDI Server hosted Information Model shall contain a protocol-specific FunctionalGroup named Identification. The Parameters of this FunctionalGroup are defined for generic protocol device types as follows:

BrowseName	DataType	Mandatory/Optional
Manufacturer	String	Mandatory
DeviceModel	String	Mandatory
SerialNumber	String	Optional
Тад	String	Optional
DeviceRevision	UInt16	Optional
ProfileId	String	Optional

Table 7 – Generic Protocol Device Types identification attributes

The BaseDataVariable instances shall be created from VARIABLE declarations with identifiers that correspond to the browse names listed in Table 7.

4.5 **Topology elements**

4.5.1 ConnectionPoint definition

The ConnectionPoint type GenericConnectionPoint shall be used to parameterize network access points using the generic protocols. The ConnectionPoint type GenericConnectionPoint is a sub type of the abstract type ConnectionPointType defined in IEC 62541-100. Table 8 specifies the representation of the GenericConnectionPoint in the AddressSpace.

Table 8 – ConnectionPoint type for Generic Protocols							
Attribute							
BrowseName	GenericConnectionPoint IEC 62769-100:2020						
IsAbstract	Falsehttps://standards	s.iteh.ai/catalog/standards/	/sist/112cfa5d-4	b7d-4e85-9892-			
References	NodeClass ddbbbbbbbbbbbbbbbbbbbbbbbbbbbbbbbbbb						
Sub type of the	Sub type of the ConnectionPointType defined in IEC 62541-100.						
HasProperty	Variable Address String PropertyType Mandatory						
HasProperty	Variable	Protocolldentifier	String	PropertyType	Mandatory		

The ConnectionPoint type GenericConnectionPoint shall be described by an EDD element contained in a Communication Device related FDI Package that can drive a generic protocol network. Actual ConnectionPoint properties are declared by VARIABLE constructs grouped together in a COLLECTION named ConnectionPoint. For this profile, it shall only contain the CONNECTION_POINT_ADDRESS, mapped to the OPC UA Property Address. In addition, the PROTOCOL specified by the COMPONENT shall be mapped to the ProtocolIdentifier Property. The following EDDL source code is an example describing a Connection Point for an ExampleProtocol. The ProtocolIdentifier defined by the PSDs (see Annex C) shall be used as the PROTOCOL name in the EDD.

```
COMPONENT ConnectionPoint_Generic
{
  LABEL "Generic Connection Point";
  CLASSIFICATION NETWORK_CONNECTION_POINT;
  CAN_DELETE FALSE;
  PROTOCOL ExampleProtocol;
  CONNECTION_POINT ConnectionPoint;
}
VARIABLE Address
{
```

```
IEC 62769-100:2020 © IEC 2020 - 13 -
LABEL "Address";
HELP "Address of the device";
TYPE EUC(<protocol-specific>);
CLASS LOCAL;
}
COLLECTION ConnectionPoint
{
LABEL "Connection Point";
MEMBERS
{
CONNECTION_POINT_ADDRESS, Address;
}
```

4.5.2 Communication Device definition

In accordance with IEC 62769-7, each FDI Communication Package shall contain an EDD element describing the communication device. The following EDDL source code in is an example describing a Communication Server.

```
COMPONENT Generic Communication Server
{
  LABEL "Generic communication server";
  PRODUCT URI "urn: Company Name: Product Name" PREVIEW
  CAN DELETE TRUE;
  CLASSIFICATION NETWORK COMPONENT RELATIONS - (Standards.iteh.ai)
  COMPONENT RELATIONS
  {
    Generic Communication_Device_Setup_9-100:2020
  }
                 https://standards.iteh.ai/catalog/standards/sist/112cfa5d-4b7d-4e85-9892-
}
                              ddbbf8250787/iec-62769-100-2020
COMPONENT RELATION Generic Communication Device Setup
   LABEL "Relation between Device and communication device";
   RELATION TYPE CHILD COMPONENT;
   COMPONENTS
   {
      Generic Communication Device (AUTO CREATE 1; )
   }
   MINIMUM NUMBER 1;
   MAXIMUM NUMBER 4;
}
```

In accordance with IEC 62769-7, each FDI Communication Package shall contain at least one EDD element describing at least one communication device component. The following EDDL source code in is an example for a generic protocol communication device:

```
COMPONENT Generic_Communication_Device
{
  LABEL "Generic communication device";
  CAN_DELETE TRUE;
  CLASSIFICATION NETWORK_COMPONENT;
  COMPONENT_RELATIONS { Generic_Service_Provider_Relation }
}
COMPONENT_RELATION Generic_Service_Provider_Relation
{
  LABEL "Relation to communication service provider";
  RELATION_TYPE CHILD_COMPONENT;
  COMPONENTS
  {
    Generic_Service_Provider{AUTO_CREATE 1;}
  }
}
```